2027 2nd International Conference on Electromagnetic Engineering & Microwave Systems

June 11-13, 2027 Hangzhou, China

EEMS 2027

www.iceems.org

Taking place from June 11 to 13, 2027 2nd International Conference on Electromagnetic Engineering & Microwave Systems (EEMS 2027) will be held in Hangzhou, China. Co-sponsored by Yangtze Delta Region Academy of Beijing Institute of Technology (Jiaxing), Zhejiang University, Hangzhou Dianzi University, and Ningbo University, the conference aims to fully leverage Hangzhou's unique strengths in fostering innovation, creating a world-class international exchange platform that brings together global academics, industry leaders, and technology innovators. It will serve as a dynamic venue for sharing cutting-edge insights, building cross-border collaboration networks, and driving technological advancements in the fields of electromagnetic engineering and microwave systems.

CALL FOR PAPERS:

Track 3: Microwave Materials and Process Technologies

Track Chair:

Prof. Zhengming Tang
China West Normal University, China

Microwave Dielectric Materials and Property Regulation

RF Magnetic Materials and Ferrite Devices

Fabrication Processes for Metamaterials/Metasurfaces

Substrate Materials and Selection for Microwave Circuits

Thin-Film/Thick-Film Preparation and Microwave Applications

3D Printing Technologies for Microwave Devices

Material Aging and Microwave Performance Stability

Characterization and Testing Technologies for Microwave Materials

More information about topics, please visit: *https://www.iceems.org/cfp.html*

SUBMISSION

The manuscript in double-column format should have at least 4 full pages and up to 10 pages. If it exceeds 5 pages, the extra page(s) will be charged. Manuscripts must be written in English and follow the instructions at Manuscript Formatting and Templates.
Submission system: *https://www.zmeeting.org/submission/eems2027*

PUBLICATION

All submissions will be sent for double-blind review. Accepted papers with registration and presentation will be published in Conference Proceedings, and submitted for index by Ei Compendex and Scopus.

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